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Authors: Jing Wang, Guang Che, Fulong Su, Zhaoxia Zho, Zhi-Quan Li, Changqing Li

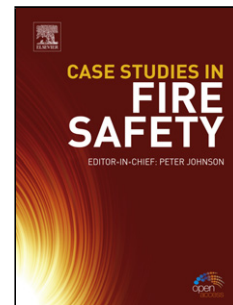
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Combined Effect of Surface Oxidation and Interfacial Intermetallic Compound Growth on Solderability Degradation of Electrodeposited Tin Thin Films on Copper Substrate due to Isothermal Ageing

Jing Wang,^a Guang Chen,^a Fulong Sun,^{a,b,c} Zhaoxia Zhou,^d Zhi-Quan Liu,^{b,c} Changqing Liu,^{a*}

a – Wolfson School of Mechanical, Electrical and Manufacturing Engineering, Loughborough University, Loughborough, LE11 3TU, United Kingdom

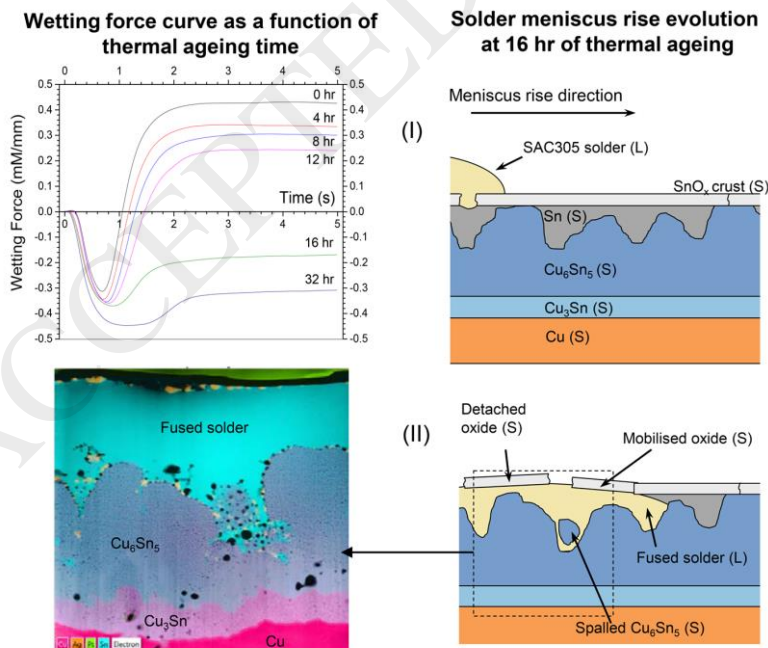
b – Institute of Metal Research, Chinese Academy of Sciences, Shenyang 110016, China

c – University of Chinese Academy of Sciences, Beijing 100049, China

d – Loughborough Materials Characterisation Centre, Department of Materials, Loughborough University, Loughborough, LE11 3TU, United Kingdom

* Corresponding author – Email: C.Liu@lboro.ac.uk

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